

MRI225.065

2 in 1 IGBT Modules

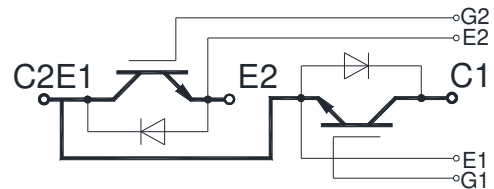
Electrical features

- $V_{CES}=650V$
- $I_{C\ nom}=225A / I_{CRM}=450A$
- Low switching losses
- Low inductance
- Fast switching and short tail current
- High power and thermal cycling capability



Typical Applications

- High Frequency Switching Application
- Motor drives
- UPS system



4. IGBT, Inverter

4.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Collector-emitter voltage	$T_{vj} = 25^{\circ}C$	V_{CES}	650	V
Continuous DC collector current	$T_C = 90^{\circ}C, T_{vj\ max} = 175^{\circ}C$	$I_{C\ nom}$	225	A
Repetitive peak collector current	$t_p = 1\ ms$	I_{CRM}	450	A
Total power dissipation	$T_C = 90^{\circ}C, T_{vj\ max} = 175^{\circ}C$	P_{tot}	830	W
Gate-emitter peak voltage		V_{GES}	+/- 20	V

4.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage	$I_C = 225 \text{ A}, V_{GE} = 15 \text{ V}$	$V_{CE,sat}$		$T_{vj} = 25^\circ\text{C}$	1.20	V
				$T_{vj} = 125^\circ\text{C}$	1.24	V
				$T_{vj} = 150^\circ\text{C}$	1.25	V
Gate threshold voltage	$I_C = 1 \text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^\circ\text{C}$	$V_{GE,th}$	4.4	5.4	6.4	V
Gate charge	$V_{GE} = -15 \text{ V} \dots +15 \text{ V}$	Q_G		2.4		μC
Internal gate resistor	$T_{vj} = 25^\circ\text{C}$	R_{Gint}		2.25		Ω
Input capacitance	$f=1\text{MHz}, T_{vj}=25^\circ\text{C}, V_{CE}=25\text{V}, V_{GE}=0\text{V}$	C_{ies}		34		nF
Reverse transfer capacitance	$f=1\text{MHz}, T_{vj}=25^\circ\text{C}, V_{CE}=25\text{V}, V_{GE}=0\text{V}$	C_{res}		0.47		nF
Collector-emitter cut-off current	$V_{CE} = 650 \text{ V}, V_{GE} = 0 \text{ V}, T_{vj} = 25^\circ\text{C}$	I_{CES}			1	mA
Gate-emitter leakage current	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}, T_{vj} = 25^\circ\text{C}$	I_{GES}			100	nA
Thermal resistance, junction to case	Per IGBT	$R_{th,Jc}$		0.27		K/W

5. Diode, Inverter

5.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Repetitive peak reverse voltage	$T_{vj} = 25^\circ\text{C}$	V_{RRM}	650	V
Continuous DC forward current		I_F	225	A
Repetitive peak forward current	$t_p = 1 \text{ ms}$	I_{FRM}	450	A

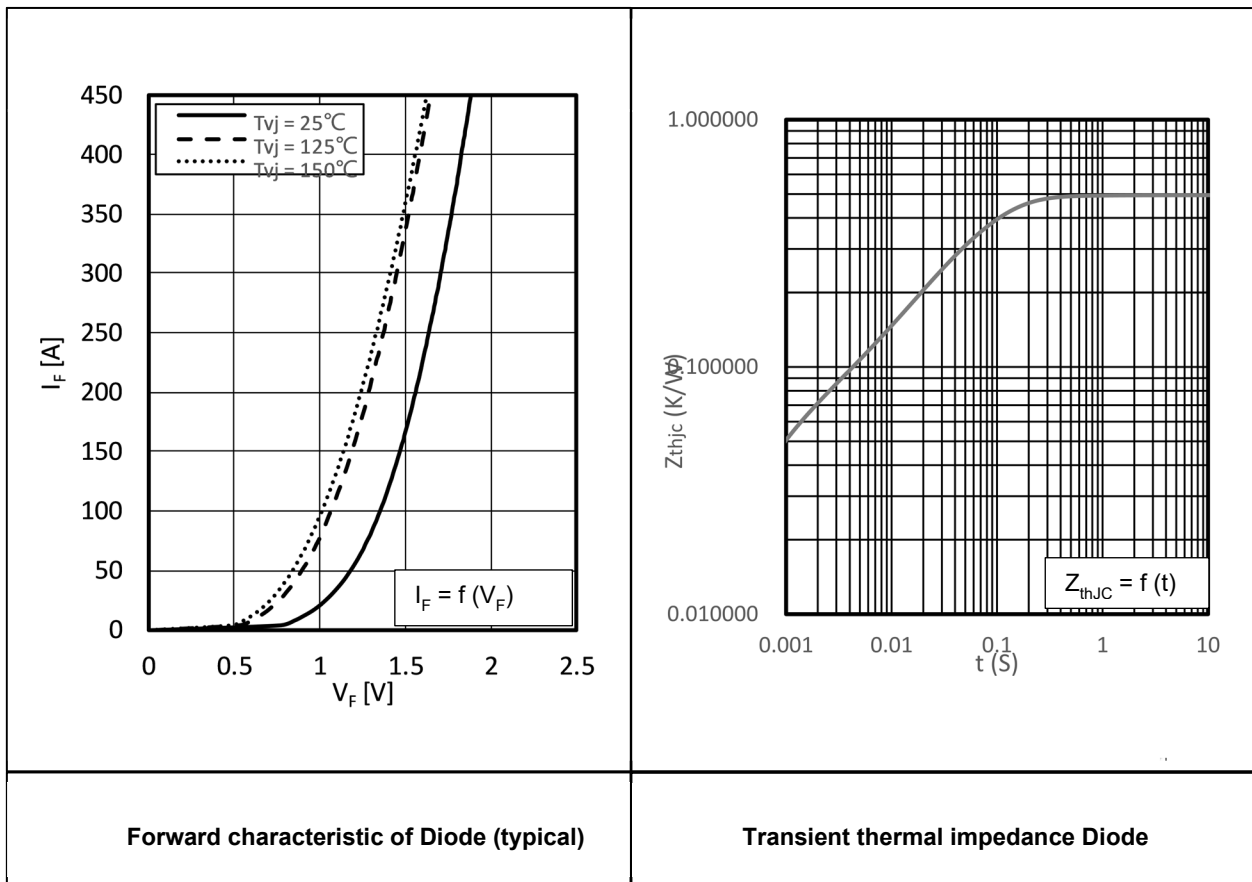
5.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Forward voltage	$I_F = 225 \text{ A}, V_{GE} = 0 \text{ V}$	V_F		$T_{vj} = 25^\circ\text{C}$	1.60	V
				$T_{vj} = 125^\circ\text{C}$	1.33	V
				$T_{vj} = 150^\circ\text{C}$	1.29	V
Thermal resistance, junction to case	Per diode	$R_{th,Jc}$		0.495		K/W

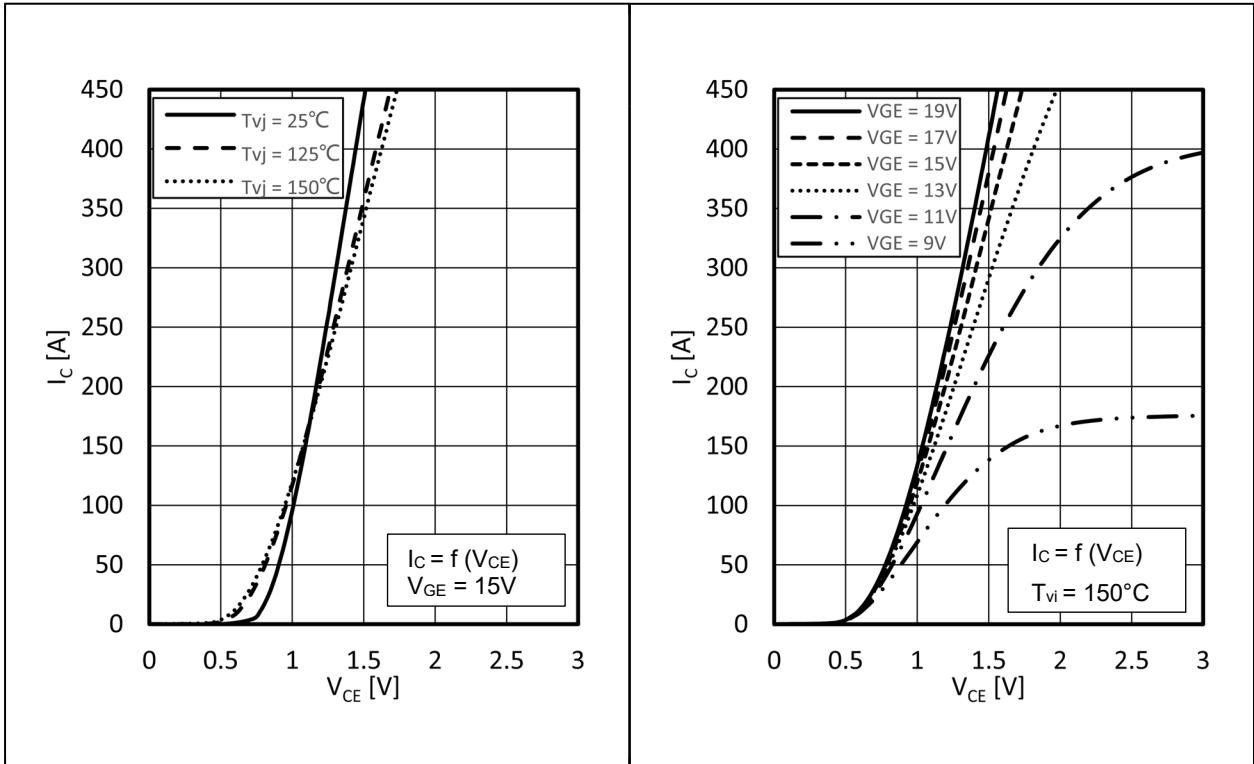
6. Module

6.1 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Isolation Voltage	RMS, f=50HZ, 1min	V_{ISOL}			4000	V
Stray inductance module		L_{sCE}		30		nH
Operation Junction Temperature		T_{jop}	-40		150	°C
Storage Temperature Range		T_{stg}	-40		125	°C
Mounting Torque	Screw M6	M	3.0		5.0	N.m
Terminal Connection Torque	Screw M5	M	2.5		5.0	N.m
Weight of Module		G		163		g

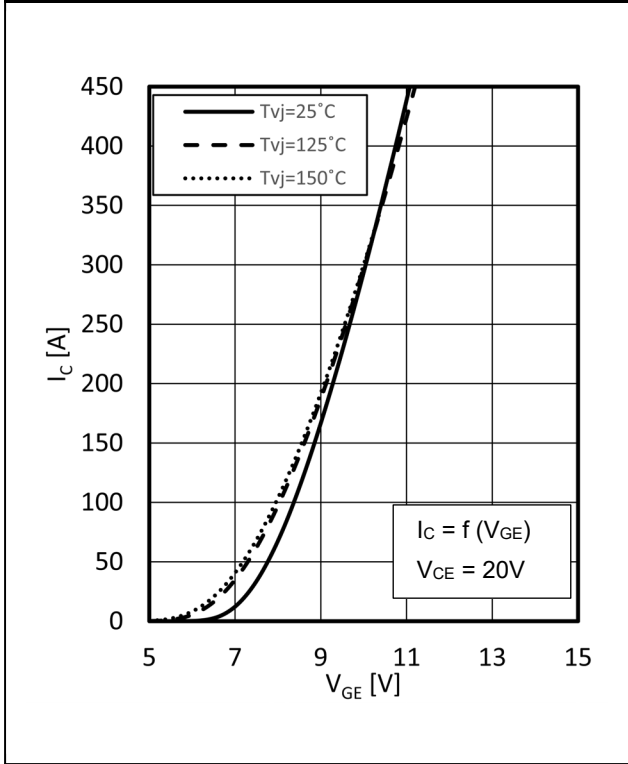


7. Characteristics Diagrams

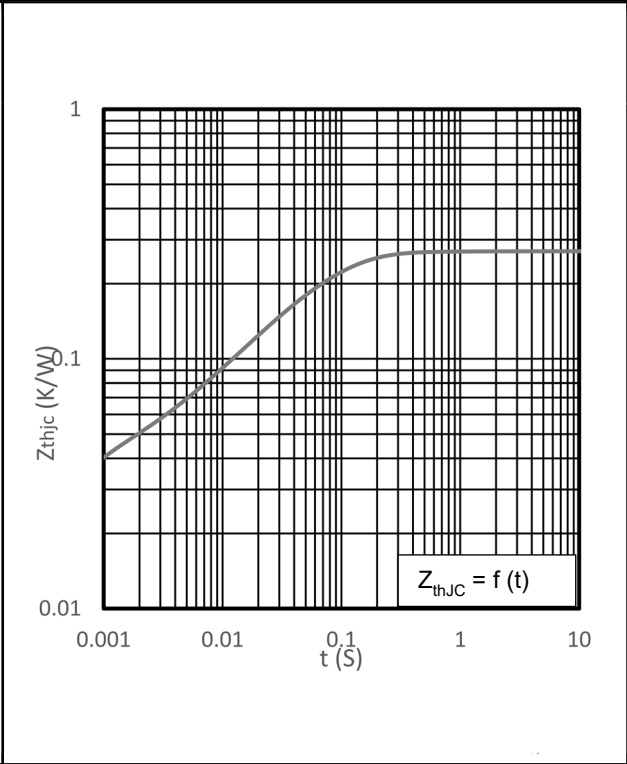


Output characteristic IGBT (typical)

Output characteristic IGBT (typical)



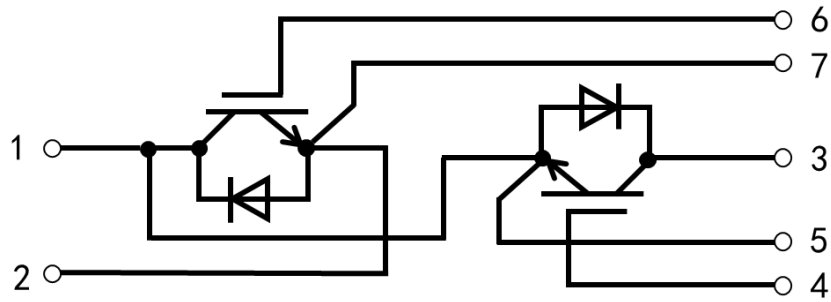
Transfer characteristic IGBT (typical)



Transient thermal impedance IGBT

Outline:

Circuit Diagram



Package Outlines

